



## electronic equipment thermal design and analysis techniques (2nd edition)

By YU JIAN ZU GAO HONG XIA XIE YONG QI

paperback. Condition: New. Ship out in 2 business day, And Fast shipping, Free Tracking number will be provided after the shipment. Paperback. Pages Number: 407 Publisher: Beijing Aerospace University Press Pub. Date :2008-11-01. electronic equipment thermal design and analysis system introduced electronic components. equipment or components and whole system thermal design. thermal analysis and related theories. including electronic equipment. heat overview of the theoretical basis for the design of electronic equipment and the cold plate fin heat sink design. chassis and circuit board conduction cooling and air-cooled design. microelectronic devices and components. thermal design of electronic equipment. radiation cooling and phase change cooling . heat pipe cooling and thermoelectric cooling thermal design of electronic equipment in the application of transient cooling of electronic devices. thermal design of electronic equipment and other new developments. Of the above thermal design and analysis techniques involving heat transfer and fluid mechanics of the basic theory. electronic equipment thermal design and analysis techniques are used fairly concise length. are described briefly. The book gives a lot of formulas. curves. charts. and specific technical parameters. the actual design of each part of the calculation examples are equipped for engineering reference. Thermal design and analysis of electronic equipment...



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